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AMETEK MOCON LAUNCHES DANSENSOR LIPPKE 5000 PACKAGE INTEGRITY TESTING SYSTEM

The new system is designed for healthcare and food packaging markets.

MINNEAPOLIS, Minn. (Nov. 6, 2020) – AMETEK MOCON, a leading global provider of package testing instruments, today announced the launch of the Dansensor® Lippke® 5000, a new package integrity testing system. The new product can measure package leaks, burst pressure, and seal strength in all types of packages, with or without a modified atmosphere.

The state-of-art design features the industry’s first test head with the sensor probe located inside the needle. The integrated design provides improved consistency and sensitivity for more accurate pressure control during the testing process so that leak, burst and creep test results are as accurate as possible.

The new package testing system also features shorter fill times, an improved pre-fill process (which prevents over-shoot), and ultimately shorter test times.

The Dansensor Lippke 5000 was designed for users on the production floor or in the laboratory. It offers a new touchscreen with a simplified, user-friendly GUI (graphical user interface) that enables easy and intuitive data capturing, storage, and export. For Production Quality Control, operators can easily set up data once and then simply transfer it from one instrument to another, making exact clones of the first units. Once operators have set up one instrument for their package types, they can copy the complete set-up, operator settings, and access levels to other instruments.

“The new Dansensor Lippke 5000’s industry-leading design and features provides a fast, easy-to-use, intuitive package testing system with optimized measuring and accuracy for packaging operations worldwide,” said Steen Andreasen, Product Manager for AMETEK MOCON in Denmark. “No other package testing system offers the accuracy afforded by having test head needles with a sense probe



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located inside the package. This, along with the product’s various configurations and accessories, will provide users with versatility they need to keep up in today’s ever-changing packaging production and packaging R&D environments.”

Andreasen noted that the new Dansensor Lippke 5000 also supports numerous standard test methods including ASTM F-1140, ASTM F-2054, ASTM F-2095, ASTM F-2096, ISO 11607 and enables compliance to 21 CFR, part 11 for data security.

Contact [AMETEK MOCON](#) to learn more. Click [here](#) to learn more about the Dansensor Lippke 5000 package testing system, including a full list of product features, technical specifications, and a description on how it works.

About AMETEK MOCON

AMETEK MOCON is recognized as the global industry standard in quality gas permeation and package testing instruments. For over 55 years, the company has delivered the broadest range of solutions globally to provide products, service and technical expertise to best fit its customers’ business needs. AMETEK MOCON’s full array of analyzers are known as the most accurate and repeatable on the market that protect and enhance its customers’ brand identity and product integrity.

AMETEK MOCON is a business unit of the Process & Analytical Instruments division of AMETEK, Inc., a leading global manufacturer of electronic instruments and electromechanical devices with annual sales of \$y billion. See ametekmocon.com for more information.